

| | | |
|--------------|---|--------------------|
| V_{DM} | = | 2800 V |
| $I_{T(AV)M}$ | = | 2630 A |
| $I_{T(RMS)}$ | = | 4130 A |
| I_{TSM} | = | 43×10^3 A |
| V_{T0} | = | 0.85 V |
| r_T | = | 0.16 mW |

Bi-Directional Control Thyristor

5STB 24Q2800

Doc. No. 5SYA1053-02 May 07

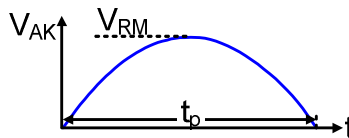
- Two thyristors integrated into one wafer
- Patented free-floating silicon technology
- Designed for energy management and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate

The electrical and thermal data are valid for one-thyristor-half of the device (unless otherwise stated)

Blocking

Maximum rated values¹⁾

| Parameter | Symbol | Conditions | 5STB 24Q2800 | Unit |
|--|----------------|--|--------------|------------------|
| Max repetitive peak forward blocking voltage | V_{RM} | $f = 50$ Hz, $t_p = 10$ ms, $T_{vj} = 5 \dots 125^\circ\text{C}$, Note 1 | 2800 | V |
| Critical rate of rise of off-state voltage | dv/dt_{crit} | Exp. to 1880 V, $T_{vj} = 125^\circ\text{C}$ | 1000 | V/ μs |



Characteristic values

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|-----------------------------|----------|---|-----|-----|-----|------|
| Max reverse leakage current | I_{RM} | V_{RM} , $T_{vj} = 125^\circ\text{C}$ | | | 400 | mA |

Note 1: Voltage de-rating factor of 0.11% per $^\circ\text{C}$ is applicable for T_{vj} below $+5^\circ\text{C}$

Mechanical data

Maximum rated values¹⁾

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|----------------|--------|------------------|-----|-----|-----|----------------|
| Mounting force | F_M | | 81 | 90 | 108 | kN |
| Acceleration | a | Device unclamped | | | 50 | m/s^2 |
| Acceleration | a | Device clamped | | | 100 | m/s^2 |

Characteristic values

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|---------------------------|--------|---|------|-----|------|------|
| Weight | m | | | | 2.1 | kg |
| Housing thickness | H | $F_M = 90$ kN, $T_a = 25^\circ\text{C}$ | 25.8 | | 26.4 | mm |
| Surface creepage distance | D_S | | 36 | | | mm |
| Air strike distance | D_a | | 15 | | | mm |

1) Maximum rated values indicate limits beyond which damage to the device may occur

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On-state

Maximum rated values ¹⁾

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|-----------------------------------|--------------|--|-----|-----|--------------------|--------|
| Average on-state current | $I_{T(AV)M}$ | Half sine wave, $T_c = 70\text{ °C}$ | | | 2630 | A |
| RMS on-state current | $I_{T(RMS)}$ | | | | 4130 | A |
| RMS on-state current | $I_{T(RMS)}$ | Full sine wave, $T_c = 70\text{ °C}$ | | | 5840 | A |
| Peak non-repetitive surge current | I_{TSM} | $t_p = 10\text{ ms}$, $T_{vj} = 125\text{ °C}$, sine wave after surge: $V_D = V_R = 0\text{ V}$ | | | 43.0×10^3 | A |
| Limiting load integral | I^2t | | | | 9.25×10^6 | A^2s |
| Peak non-repetitive surge current | I_{TSM} | $t_p = 8.3\text{ ms}$, $T_{vj} = 125\text{ °C}$, sine wave after surge: $V_D = V_R = 0\text{ V}$ | | | 46.0×10^3 | A |
| Limiting load integral | I^2t | | | | 8.78×10^6 | A^2s |

Characteristic values

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|-------------------|----------|--|-----|-----|------|-----------|
| On-state voltage | V_T | $I_T = 3000\text{ A}$, $T_{vj} = 125\text{ °C}$ | | | 1.35 | V |
| Threshold voltage | V_{T0} | $I_T = 1500\text{ A} - 4500\text{ A}$, $T_{vj} = 125\text{ °C}$ | | | 0.85 | V |
| Slope resistance | r_T | | | | 0.16 | $m\Omega$ |
| Holding current | I_H | $T_{vj} = 25\text{ °C}$ | | | 250 | mA |
| | | $T_{vj} = 125\text{ °C}$ | | | 150 | mA |
| Latching current | I_L | $T_{vj} = 25\text{ °C}$ | | | 500 | mA |
| | | $T_{vj} = 125\text{ °C}$ | | | 300 | mA |

Switching

Maximum rated values ¹⁾

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|--|----------------|--|-----|-----|-----|-----------|
| Critical rate of rise of on-state current | di/dt_{crit} | $T_{vj} = 125\text{ °C}$, $I_{TRM} = 3000\text{ A}$, Cont. $f = 50\text{ Hz}$ | | | 250 | $A/\mu s$ |
| Critical rate of rise of on-state current | di/dt_{crit} | $V_D \leq 1880\text{ V}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu s$ Cont. $f = 1\text{ Hz}$ | | | 500 | $A/\mu s$ |
| Circuit commutated turn-off time | t_q | $T_{vj} = 125\text{ °C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1.5\text{ A}/\mu s$, $V_D \leq 0.67 \cdot V_{RM}$, $dv_D/dt = 20\text{ V}/\mu s$, | 400 | | | μs |
| Critical rate of rise of commutating voltage | dv/dt_{com} | $T_{vj} = 125\text{ °C}$, $V_R \leq 0.67 \cdot V_{RM}$ | | | 500 | $V/\mu s$ |

Characteristic values

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|--------------------------|----------|--|------|-----|------|----------|
| Reverse recovery charge | Q_{rr} | $T_{vj} = 125\text{ °C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1.5\text{ A}/\mu s$ | 1000 | | 2100 | μAs |
| Reverse recovery current | I_{RM} | | 30 | | 80 | A |
| Gate turn-on delay time | t_{gd} | $T_{vj} = 25\text{ °C}$, $V_D = 0.4 \cdot V_{RM}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu s$ | | | 3 | μs |

Triggering

Maximum rated values ¹⁾

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|--------------------------------------|--------------|---------------------|------------|-----|-----|------|
| Peak forward gate voltage | V_{FGM} | | | | 12 | V |
| Max. rated peak forward gate current | I_{FGM} | | | | 10 | A |
| Peak reverse gate voltage | V_{RGM} | | | | 10 | V |
| Max. rated gate power loss | P_G | For DC gate current | | | 3 | W |
| Max. rated peak forward gate power | $P_{GM(AV)}$ | | see Fig. 9 | | | W |

Characteristic values

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|--------------------------|----------|--|-----|-----|-----|------|
| Gate trigger voltage | V_{GT} | $T_{vj} = 25\text{ °C}$ | | | 2.6 | V |
| Gate trigger current | I_{GT} | $T_{vj} = 25\text{ °C}$ | | | 400 | mA |
| Gate non-trigger voltage | V_{GD} | $V_D = 0.4 \times V_{RM}$, $T_{vj} = 125\text{ °C}$ | 0.3 | | | V |
| Gate non-trigger current | I_{GD} | $V_D = 0.4 \times V_{RM}$ | 10 | | | mA |

Thermal

Maximum rated values ¹⁾

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|--------------------------------------|-----------|------------|-----|-----|-----|------|
| Operating junction temperature range | T_{vj} | | | | 125 | °C |
| Storage temperature range | T_{stg} | | -40 | | 140 | °C |

Characteristic values

| Parameter | Symbol | Conditions | min | typ | max | Unit |
|--|---------------|--|-----|-----|-----|------|
| Thermal resistance junction to case (Valid for one thyristor half no heat flow to the second half.) | $R_{th(j-c)}$ | Double-side cooled $F_m = 81...108\text{ kN}$ | | | 10 | K/kW |
| | $R_{th(j-c)}$ | Single-side cooled $F_m = 81...108\text{ kN}$ | | | 20 | K/kW |
| Thermal resistance case to heatsink | $R_{th(c-h)}$ | Double-side cooled $F_m = 81...108\text{ kN}$ | | | 2 | K/kW |
| | $R_{th(c-h)}$ | Single-side cooled $F_m = 81...108\text{ kN}$ | | | 4 | K/kW |

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

| i | 1 | 2 | 3 | 4 |
|--------------|--------|--------|--------|--------|
| R_i (K/kW) | 6.500 | 1.470 | 1.310 | 0.710 |
| τ_i (s) | 0.5205 | 0.1075 | 0.0194 | 0.0073 |

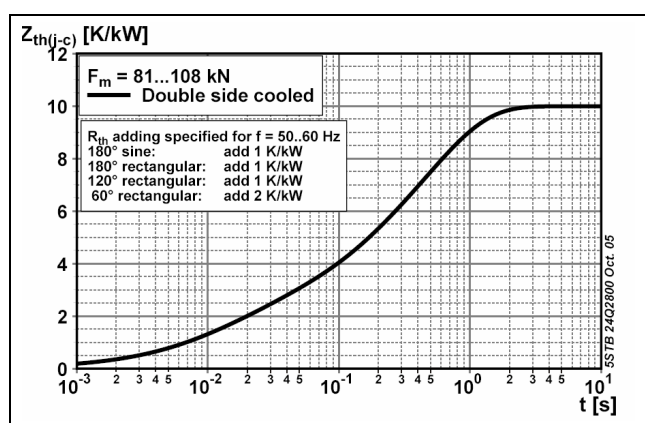


Fig. 1 Transient thermal impedance (junction-to-case) vs. time

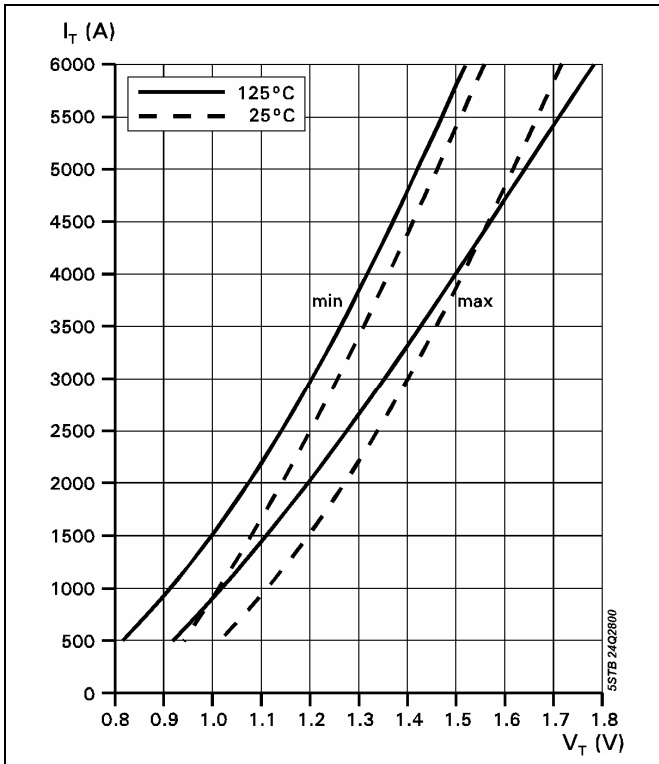


Fig. 2 On-state voltage characteristics

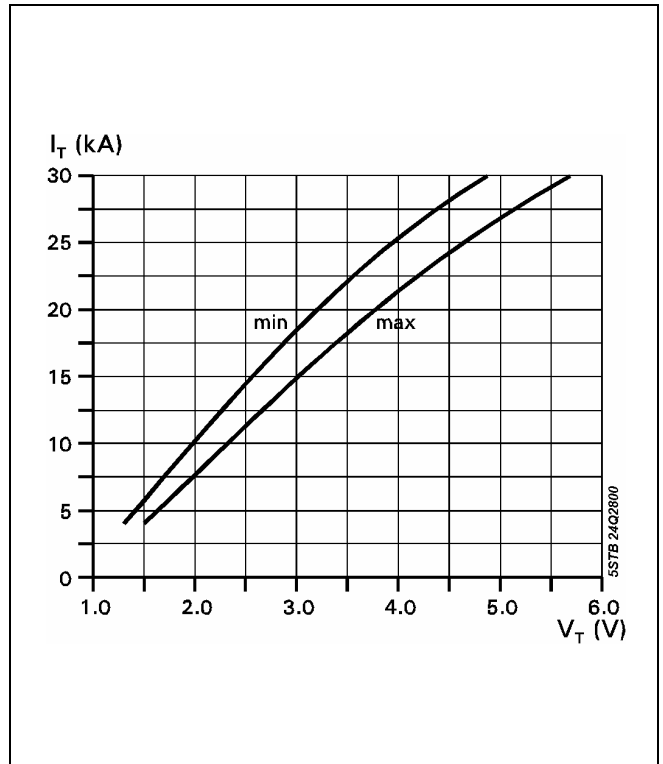


Fig. 3 On-state characteristics.
 $T_j = 125^\circ\text{C}$, 10ms half sine.

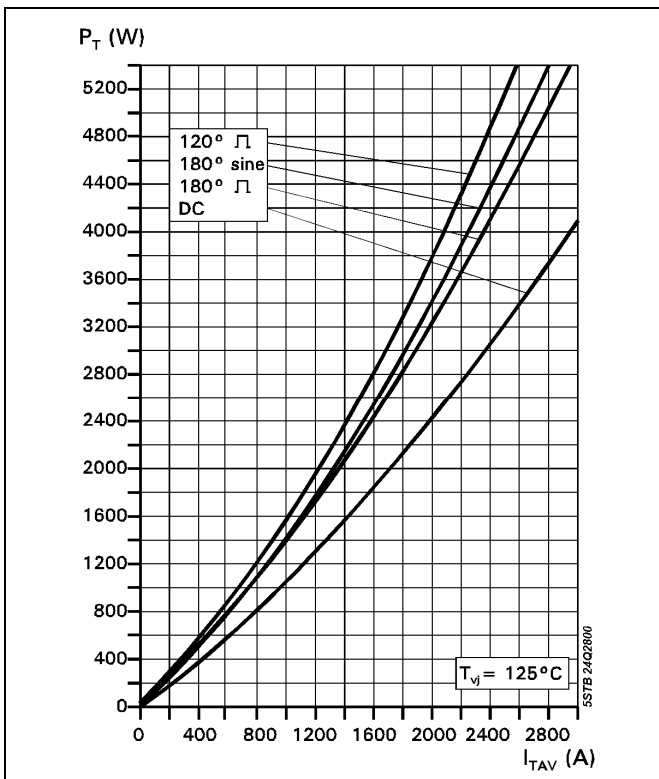


Fig. 4 On-state power dissipation vs. mean on-state current. Turn-on losses excluded.

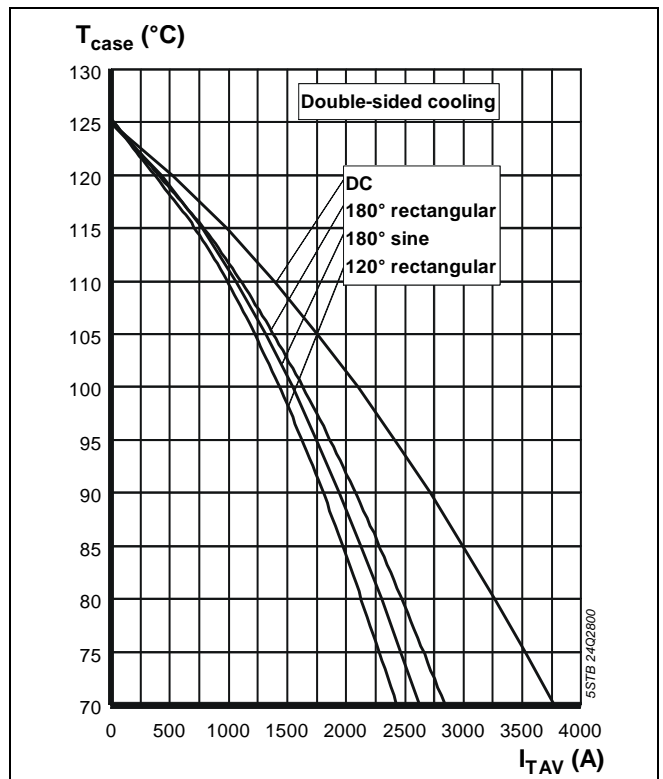


Fig. 5 Max. permissible case temperature vs. mean on-state current. Switching losses ignored.

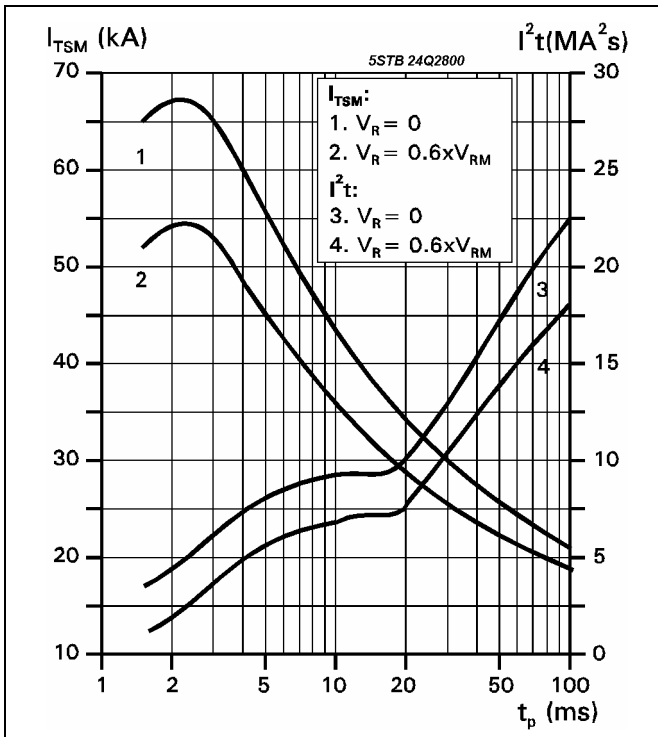


Fig. 6 Surge on-state current vs. pulse length. Half-sine wave.

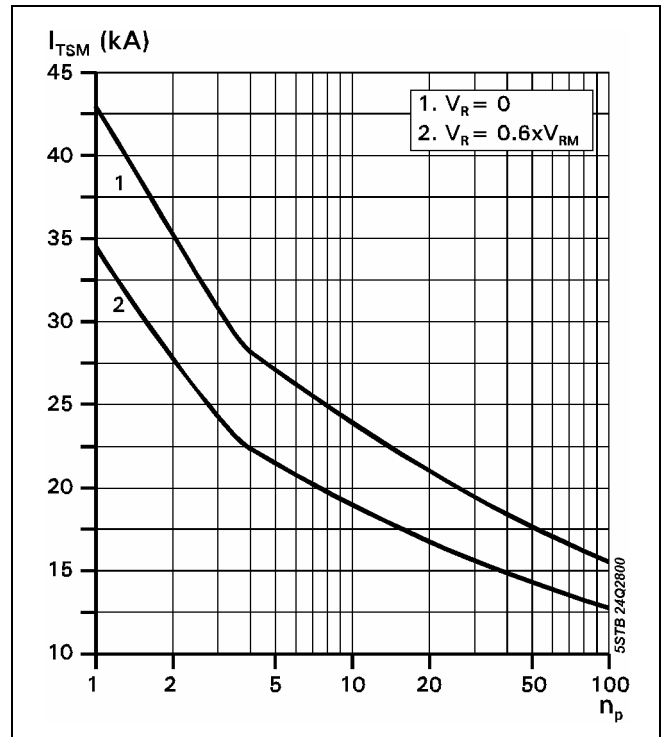


Fig. 7 Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.

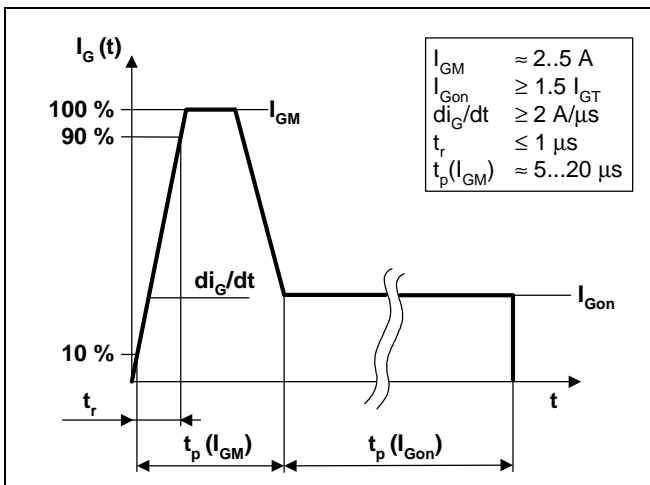


Fig. 8 Recommended gate current waveform

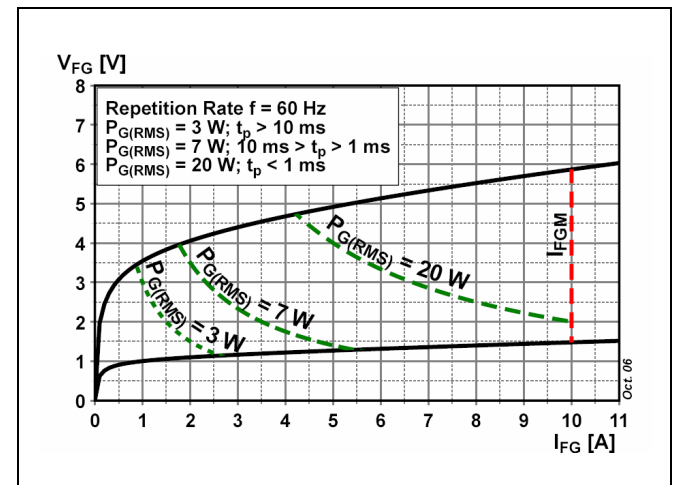


Fig. 9 Max. peak gate power loss

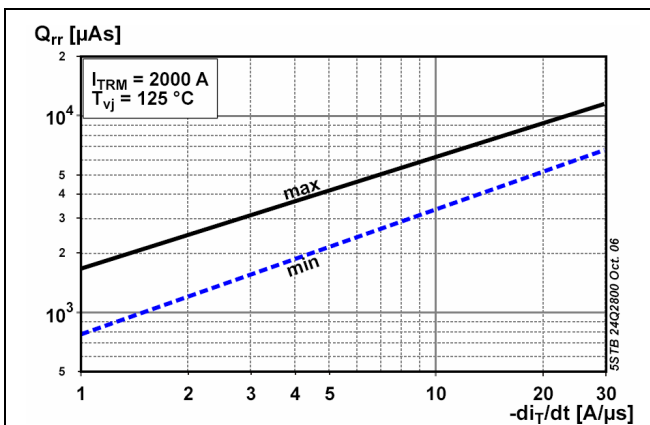


Fig. 10 Reverse recovery charge vs. decay rate of on-state current

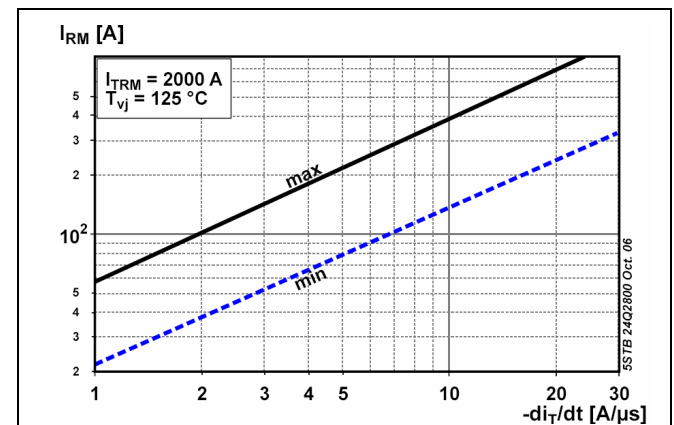


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current

Turn-on and Turn-off losses

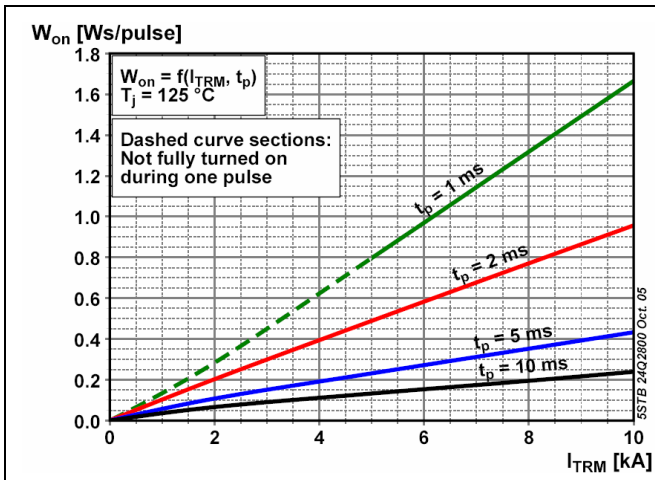


Fig. 12 Turn-on energy, half sinusoidal waves

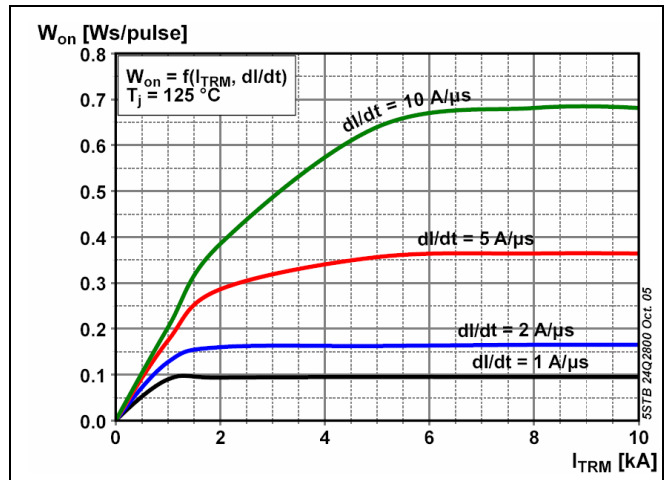


Fig. 13 Turn-on energy, rectangular waves

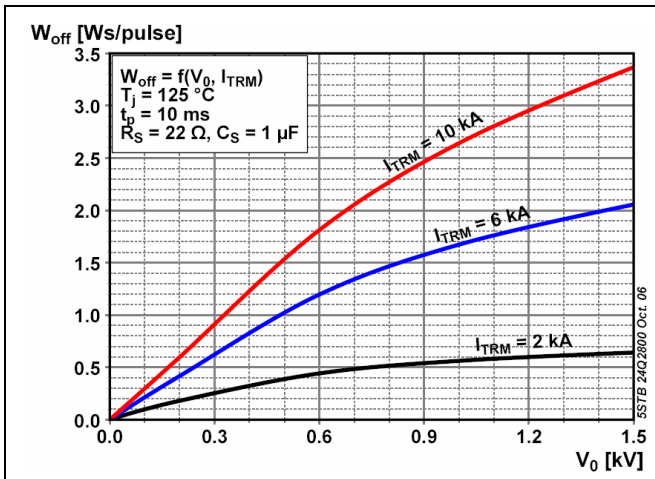


Fig. 14 Turn-off energy, half sinusoidal waves

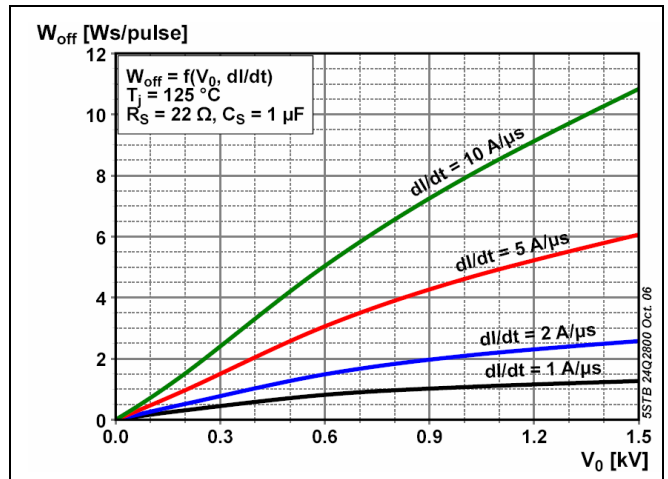


Fig. 15 Turn-off energy, rectangular waves

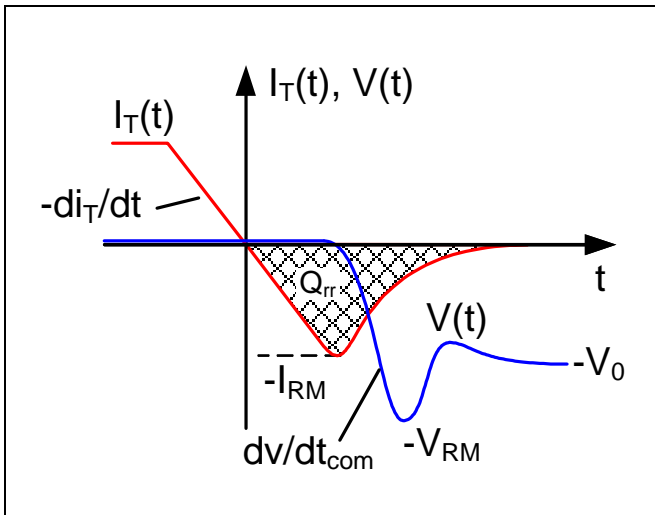


Fig. 16 Current and voltage waveforms at turn-off

Total power loss for repetitive waveforms:

$$P_{TOT} = P_T + W_{on} \cdot f + W_{off} \cdot f$$

where

$$P_T = \frac{1}{T} \int_0^T I_T \cdot V_T(I_T) dt$$

Fig. 17 Relationships for power loss

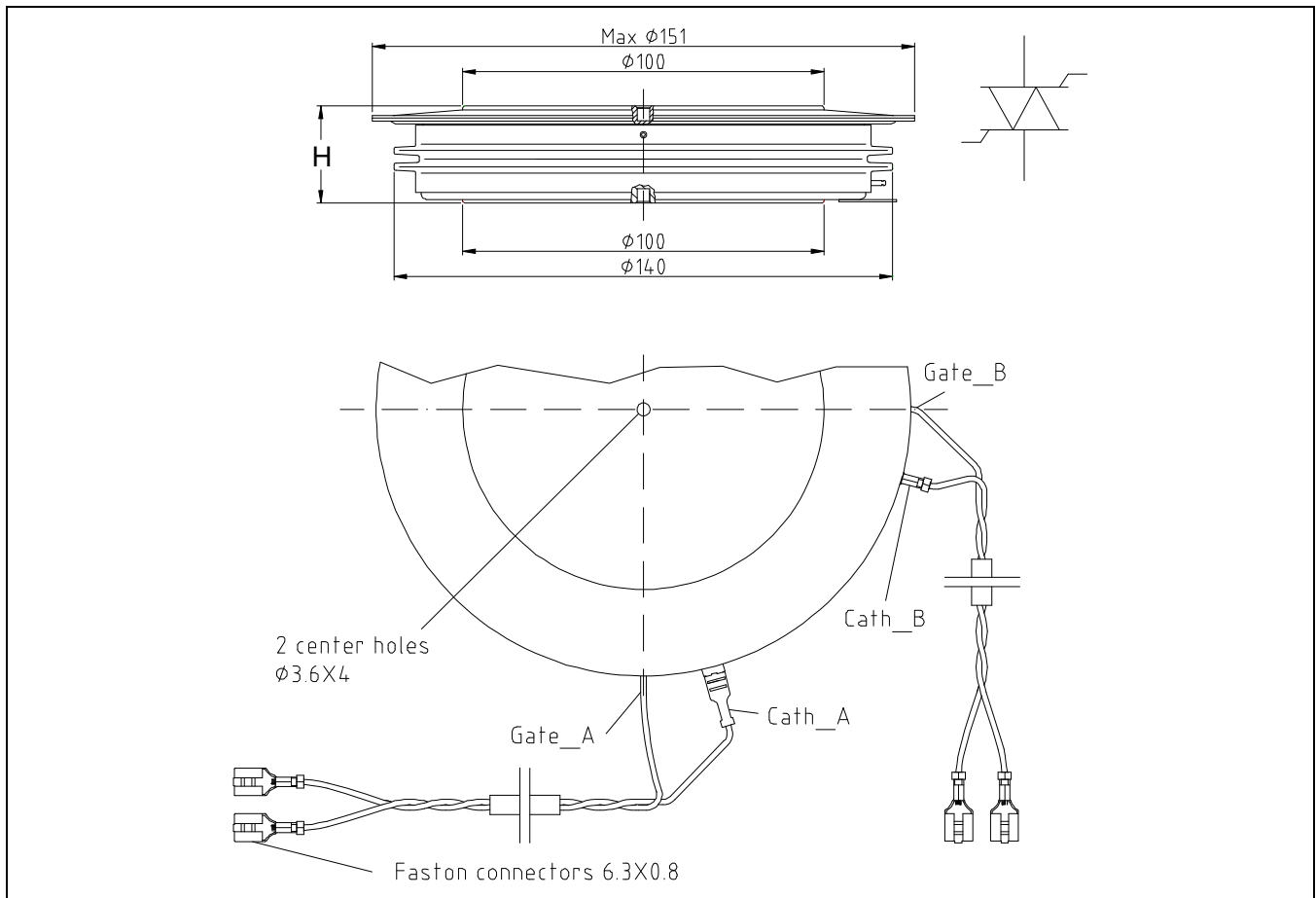


Fig. 18 Device Outline Drawing

Related documents:

| | |
|-----------|---|
| 5SYA 2020 | Design of RC-Snubber for Phase Control Applications |
| 5SYA 2049 | Voltage definitions for phase control thyristors and diodes |
| 5SYA 2051 | Voltage ratings of high power semiconductors |
| 5SYA 2034 | Gate-Drive Recommendations for PCT's |
| 5SYA 2036 | Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors |
| 5SZK 9104 | Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE available on request, please contact factory |
| 5SZK 9105 | Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION available on request, please contact factory |

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